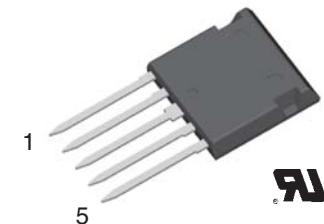
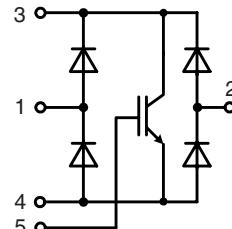


Bidirectional Switch with NPT³ IGBT and fast Diode Bridge in ISOPLUS i4-PACTM

I_{C25} = 50 A
V_{CES} = 1200 V
V_{CE(sat) typ.} = 2.0 V



IGBT

Symbol	Conditions	Maximum Ratings		
V _{CES}	T _{VJ} = 25°C to 150°C	1200	V	
V _{GES}		± 20	V	
I _{C25}	T _C = 25°C	50	A	
I _{C90}	T _C = 90°C	32	A	
I _{CM}	V _{GE} = ±15 V; R _G = 39 Ω; T _{VJ} = 125°C	50	A	
V _{CEK}	RBSOA, Clamped inductive load; L = 100 μH	V _{CES}		
t _{sc}	V _{CE} = 900V; V _{GE} = ±15 V; R _G = 39 Ω; T _{VJ} = 125°C (SCSOA) non-repetitive	10	μs	
P _{tot}	T _C = 25°C	200	W	

Symbol	Conditions	Characteristic Values		
		(T _{VJ} = 25°C, unless otherwise specified)	min.	typ.
V _{CE(sat)}	I _C = 30 A; V _{GE} = 15 V; T _{VJ} = 25°C T _{VJ} = 125°C	2.0 2.3	2.6	V
V _{GE(th)}	I _C = 1 mA; V _{GE} = V _{CE}	4.5	6.5	V
I _{CES}	V _{CE} = V _{CES} ; V _{GE} = 0 V; T _{VJ} = 25°C T _{VJ} = 125°C	0.4 0.4	0.4	mA
I _{GES}	V _{CE} = 0 V; V _{GE} = ± 20 V		200	nA
t _{d(on)} t _r t _{d(off)} t _f E _{on} E _{off}	Inductive load, T _{VJ} = 125°C V _{CE} = 600 V; I _C = 30 A V _{GE} = ±15 V; R _G = 39 Ω	85 50 440 50 4.6 2.2	ns ns ns ns mJ mJ	
C _{ies} Q _{Gon}	V _{CE} = 25 V; V _{GE} = 0 V; f = 1 MHz V _{CE} = 600 V; V _{GE} = 15 V; I _C = 35 A	2 150	nF nC	
R _{thJC} R _{thJS}		1.2	0.6 K/W K/W	

Features

- NPT³ IGBT
 - low saturation voltage
 - positive temperature coefficient for easy paralleling
 - fast switching
 - short tail current for optimized performance in resonant circuits
- HiPerFREDTM diodes
 - fast reverse recovery
 - low operating forward voltage
 - low leakage current
- ISOPLUS i4-PACTM package
 - isolated back surface
 - low coupling capacity between pins and heatsink
 - enlarged creepage towards heatsink
 - application friendly pinout
 - low inductive current path
 - high reliability
 - industry standard outline
 - UL registered, E 72873

Applications

switches to control bidirectional current flow by a single control signal:

- matrix converters
- spare matrix converters
- AC controllers

Diodes

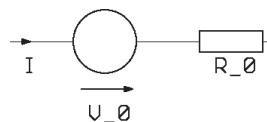
Symbol	Conditions	Maximum Ratings		
I_{F25}	$T_C = 25^\circ C$	48	A	
I_{F90}	$T_C = 90^\circ C$	25	A	

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 30 A; T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	2.4 1.8	2.8 V	V
I_{RM} t_{rr}		27 150	A ns	
R_{thJC} R_{thJS}	(per diode)	1.6	1.3 K/W K/W	

Component

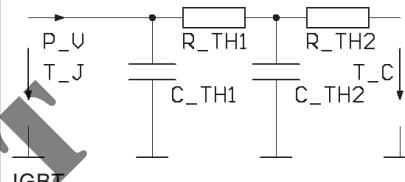
Symbol	Conditions	Maximum Ratings		
T_{VJ}		-55...+150	°C	
T_{stg}		-55...+125	°C	
V_{ISOL}	$I_{ISOL} \leq 1 mA; 50/60 Hz$	2500	V~	
F_c	mounting force with clip	20...120	N	

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
C_p	coupling capacity between shorted pins and mounting tab in the case	40	pF	
$d_s d_A$ $d_s d_A$	pin - pin pin - backside metal	1.7 5.5		mm mm
Weight		9		g

Equivalent Circuits for Simulation**Conduction**

IGBT (typ. at $V_{GE} = 15 V; T_J = 125^\circ C$)
 $V_0 = 0.95 V; R_0 = 45 m\Omega$

Diode (typ. at $T_J = 125^\circ C$)
 $V_0 = 1.26 V; R_0 = 15 m\Omega$

Thermal Response

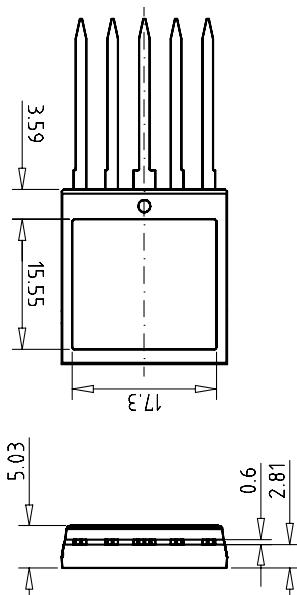
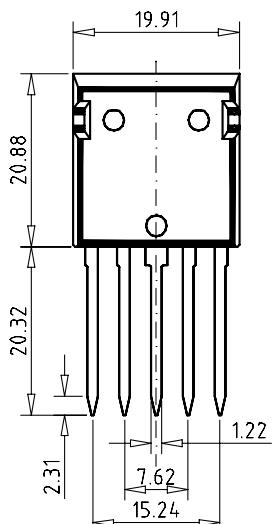
$$C_{th1} = 0.067 J/K; R_{th1} = 0.108 K/W$$

$$C_{th2} = 0.175 J/K; R_{th2} = 0.491 K/W$$

Diode

$$C_{th1} = 0.039 J/K; R_{th1} = 0.337 K/W$$

$$C_{th2} = 0.090 J/K; R_{th2} = 0.963 K/W$$

Dimensions in mm (1 mm = 0.0394")

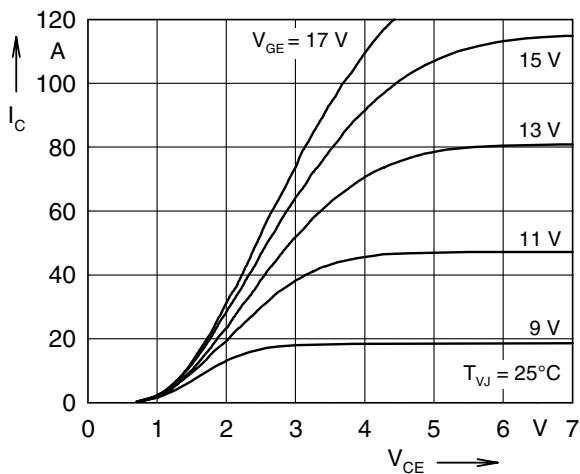


Fig. 1 Typ. output characteristics

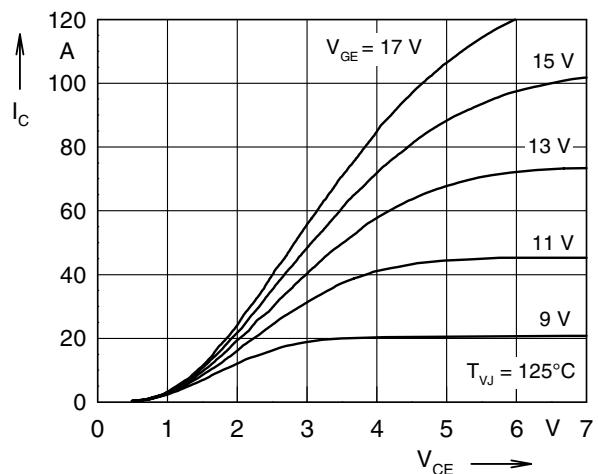


Fig. 2 Typ. output characteristics

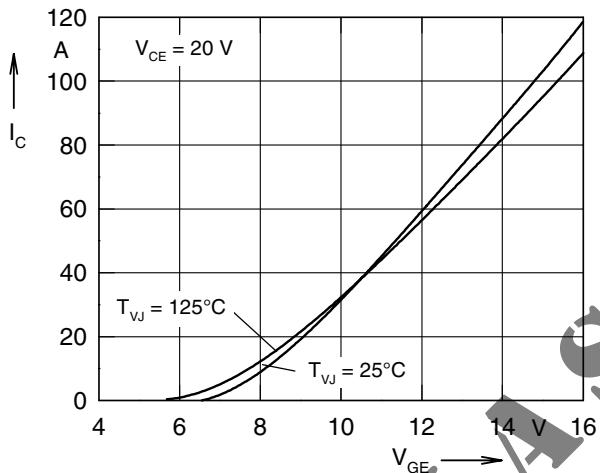


Fig. 3 Typ. transfer characteristics

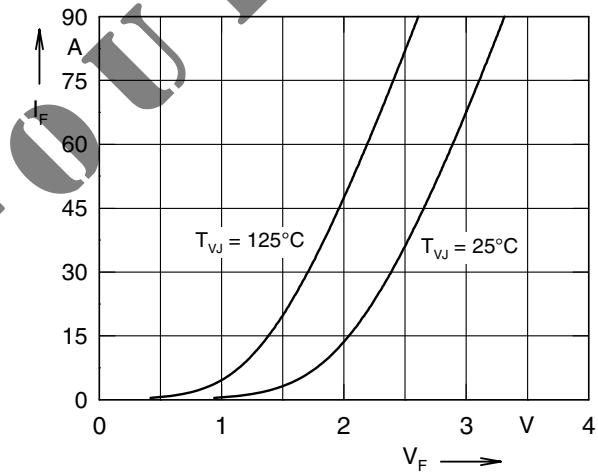


Fig. 4 Typ. forward characteristics of free wheeling diode

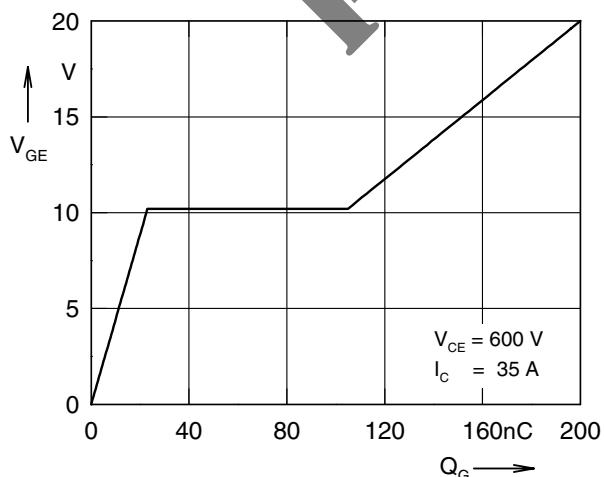


Fig. 5 Typ. turn on gate charge

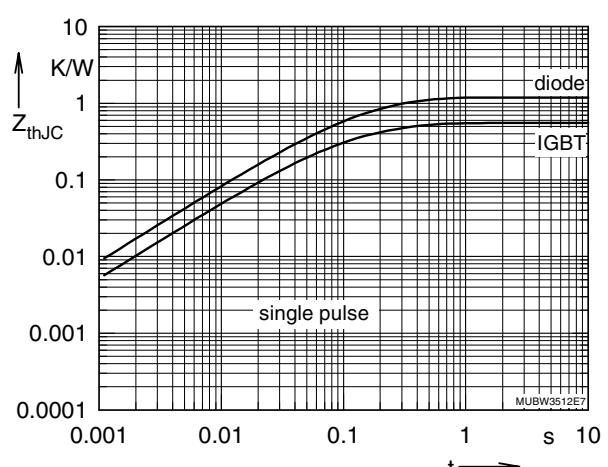


Fig. 6 Typ. transient thermal impedance

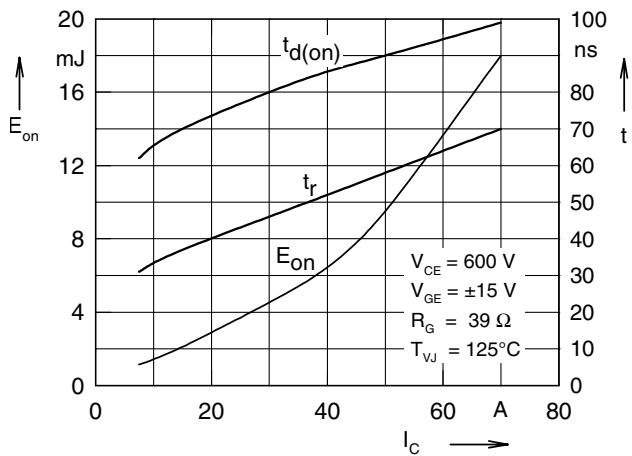


Fig. 7 Typ. turn on energy and switching times versus collector current

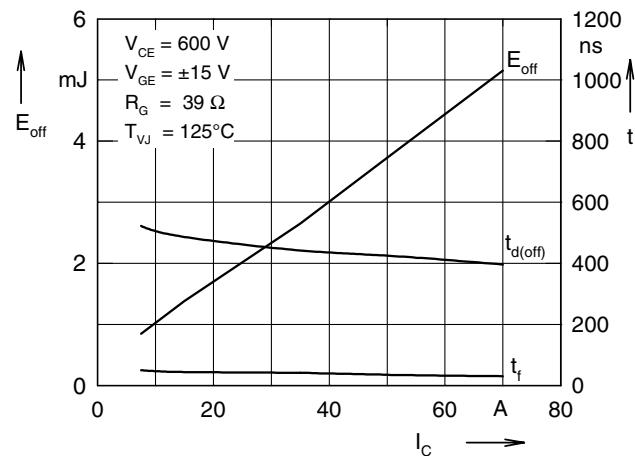


Fig. 8 Typ. turn off energy and switching times versus collector current

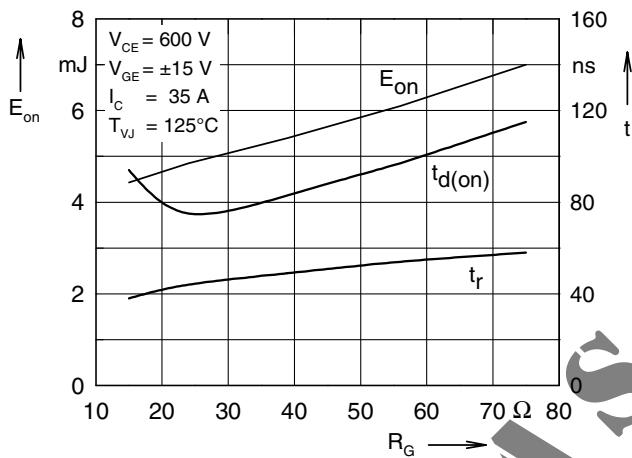


Fig. 9 Typ. turn on energy and switching times versus gate resistor

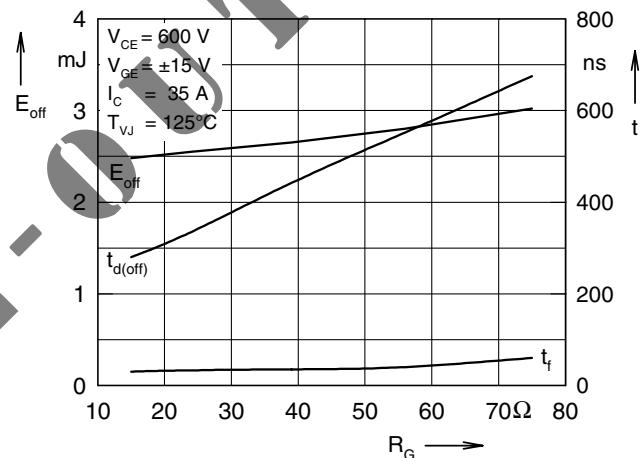


Fig.10 Typ. turn off energy and switching times versus gate resistor